CY7C1046DV33

4-Mbit (1 M × 4) Static RAM

Features

- Pin- and function-compatible with CY7C1046CV33
- High speed
  - t_{AA} = 10 ns
- Low active power
  - I_{CC} = 90 mA @ 10 ns
- Low CMOS standby power
  - I_{SB2} = 10 mA
- 2.0 V data retention
- Automatic power-down when deselected
- TTL-compatible inputs and outputs
- Easy memory expansion with $\overline{CE}$ and $\overline{OE}$ features
- Available in lead-free 400-mil-wide 32-pin SOJ package

Functional Description

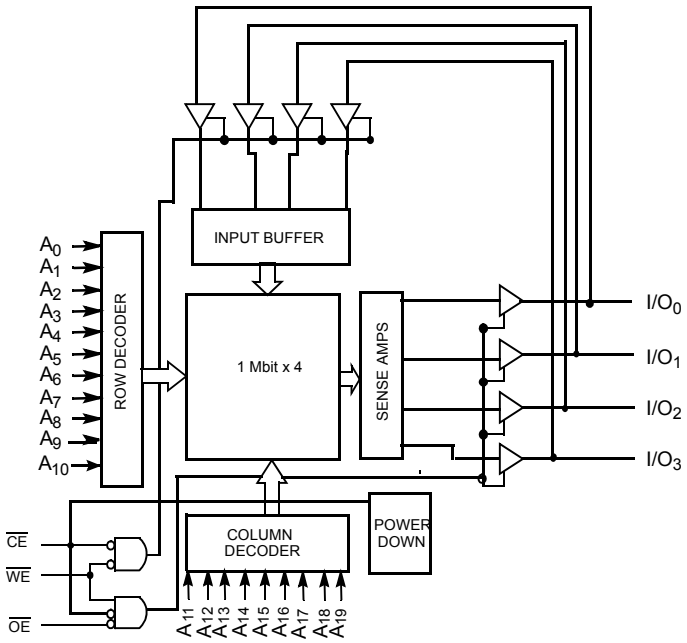
The CY7C1046DV33[1] is a high-performance CMOS static RAM organized as 1M words by 4 bits. Easy memory expansion is provided by an active LOW Chip Enable ($\overline{CE}$), an active LOW Output Enable ($\overline{OE}$), and tri-state drivers. Writing to the device is accomplished by taking Chip Enable ($\overline{CE}$) and Write Enable ($\overline{WE}$) inputs LOW. Data on the four I/O pins (I/O_0 through I/O_3) is then written into the location specified on the address pins (A_0 through A_{19}).

Reading from the device is accomplished by taking Chip Enable ($\overline{CE}$) and Output Enable ($\overline{OE}$) LOW while forcing Write Enable ($\overline{WE}$) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The four input/output pins (I/O_0 through I/O_3) are placed in a high-impedance state when the device is deselected ($\overline{CE}$ HIGH), the outputs are disabled ($\overline{OE}$ HIGH), or during a Write operation ($\overline{CE}$ LOW, and $\overline{WE}$ LOW).

The CY7C1046DV33 is available in a standard 400-mil-wide 32-pin SOJ package with center power and ground (revolutionary) pinout.

Logic Block Diagram



Note

1. For guidelines on SRAM system design, please refer to the *System Design Guidelines* Cypress application note, available on the internet at www.cypress.com.

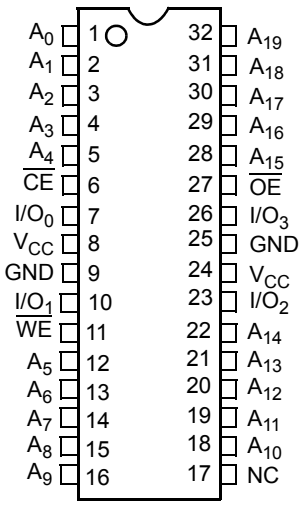
Contents

Selection Guide

	–10	Unit
Maximum access time	10	ns
Maximum operating current	90	mA
Maximum CMOS standby current	10	mA

Pin Configuration

SOJ
Top View



Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device. User guidelines are not tested.

Storage temperature ..... –65 °C to +150 °C

Ambient temperature with power applied ..... –55 °C to +125 °C

Supply voltage on V_{CC} to relative GND[2] ..... –0.3 to +4.6 V

DC voltage applied to outputs in high Z State[2] ..... –0.3 V to V_{CC} + 0.3 V

DC input voltage[2] ..... –0.3 V to V_{CC} + 0.3 V

Current into outputs (LOW) ..... 20 mA

Static discharge voltage ..... > 2001 V (per MIL-STD-883, method 3015)

Latch-up current ..... > 200 mA

Operating Range

Range	Ambient Temperature	V_{CC}
Industrial	–40 °C to +85 °C	3.3 V ± 0.3 V

DC Electrical Characteristics

Over the Operating Range

Parameter	Description	Test Conditions		–10		Unit
				Min	Max	
V_{OH}	Output HIGH voltage	V_{CC} = Min, I_{OH} = –4.0 mA		2.4	–	V
V_{OL}	Output LOW voltage	V_{CC} = Min, I_{OL} = 8.0 mA		–	0.4	V
V_{IH}	Input HIGH voltage			2.0	V_{CC} + 0.3	V
V_{IL}	Input LOW voltage[2]			–0.3	0.8	V
I_{IX}	Input leakage current	GND ≤ V_I ≤ V_{CC}		–1	+1	µA
I_{OZ}	Output leakage current	GND ≤ V_{OUT} ≤ V_{CC}, output disabled		–1	+1	µA
I_{CC}	V_{CC} operating supply current	V_{CC} = Max, f = f_{MAX} = $1/t_{RC}$	100 MHz	–	90	mA
			83 MHz	–	80	
			66 MHz	–	70	mA
			40 MHz	–	60	
I_{SB1}	Automatic CE Power-Down Current —TTL inputs	Max V_{CC}, $\overline{CE}$ ≥ V_{IH}, V_{IN} ≥ V_{IH} or V_{IN} ≤ V_{IL}, f = f_{MAX}		–	20	mA
I_{SB2}	Automatic CE Power-Down Current —CMOS inputs	Max V_{CC}, $\overline{CE}$ ≥ V_{CC} – 0.3 V, V_{IN} ≥ V_{CC} – 0.3 V, or V_{IN} ≤ 0.3 V, f = 0		–	10	mA

Capacitance[3]

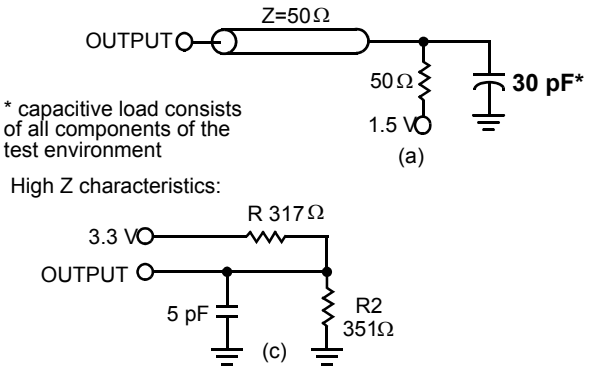
Parameter	Description	Test Conditions	Max	Unit
C_{IN}	Input capacitance	T_A = 25 °C, f = 1 MHz, V_{CC} = 3.3 V	8	pF
C_{OUT}	I/O capacitance		8	pF

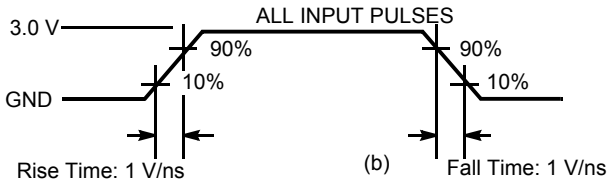
Thermal Resistance[3]

Parameter	Description	Test Conditions	SOJ Package	Unit
Θ_{JA}	Thermal resistance (Junction to Ambient)	Still Air, soldered on a 3 × 4.5 inch, four-layer printed circuit board	53.44	°C/W
Θ_{JC}	Thermal resistance (Junction to Case)		38.25	°C/W

Notes
2. V_{IL} (min) = –2.0 V and V_{IH}(max) = V_{CC} + 2 V for pulse durations of less than 20 ns.
3. Tested initially and after any design or process changes that may affect these parameters.

AC Test Loads and Waveforms[4]





Note
4. AC characteristics (except high Z) are tested using the load conditions shown in (a). High Z characteristics are tested for all speeds using the test load shown in (c).

AC Switching Characteristics

Over the Operating Range[5]

Parameter	Description	–10		Unit
		Min	Max	
Read Cycle				
t_{power}[6]	V_{CC}(typical) to the first access	100	–	µs
t_{RC}	Read cycle time	10	–	ns
t_{AA}	Address to data valid	–	10	ns
t_{OHA}	Data hold from address change	3	–	ns
t_{ACE}	$\overline{CE}$ LOW to data valid	–	10	ns
t_{DOE}	$\overline{OE}$ LOW to data valid	–	5	ns
t_{LZOE}	$\overline{OE}$ LOW to low Z[8]	0	–	ns
t_{HZOE}	$\overline{OE}$ HIGH to high Z[7, 8]	–	5	ns
t_{LZCE}	$\overline{CE}$ LOW to low Z[8]	3	–	ns
t_{HZCE}	$\overline{CE}$ HIGH to high Z[7, 8]	–	5	ns
t_{PU}	$\overline{CE}$ LOW to power-up	0	–	ns
t_{PD}	$\overline{CE}$ HIGH to power-down	–	10	ns
Write Cycle[9, 10]				
t_{WC}	Write cycle time	10	–	ns
t_{SCE}	$\overline{CE}$ LOW to write end	7	–	ns
t_{AW}	Address set-up to write end	7	–	ns
t_{HA}	Address hold from write end	0	–	ns
t_{SA}	Address set-up to write start	0	–	ns
t_{PWE}	$\overline{WE}$ pulse width	7	–	ns
t_{SD}	Data set-up to write end	5	–	ns
t_{HD}	Data hold from write end	0	–	ns
t_{LZWE}	$\overline{WE}$ HIGH to low Z[8]	3	–	ns
t_{HZWE}	$\overline{WE}$ LOW to high Z[7, 8]	–	5	ns

Notes

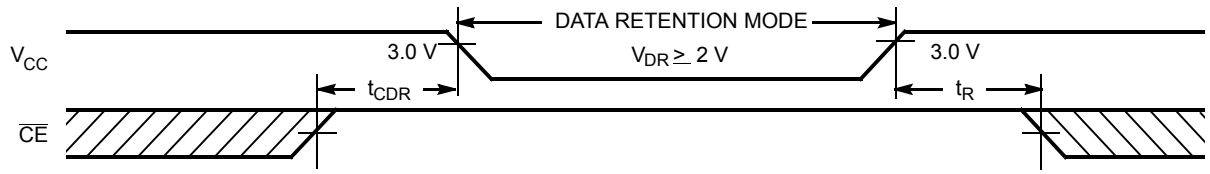
5. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5 V, input pulse levels of 0 to 3.0 V.
6. t_{POWER} gives the minimum amount of time that the power supply should be at stable, typical V_{CC} values until the first memory access can be performed.
7. t_{HZOE}, t_{HZCE}, and t_{HZWE} are specified with a load capacitance of 5 pF as in part (c) of AC Test Loads. Transition is measured when the outputs enter a high impedance state.
8. At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZOE} is less than t_{LZOE}, and t_{HZWE} is less than t_{LZWE} for any given device.
9. The internal Write time of the memory is defined by the overlap of $\overline{CE}$ LOW, and $\overline{WE}$ LOW. $\overline{CE}$ and $\overline{WE}$ must be LOW to initiate a Write, and the transition of either of these signals can terminate the Write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the Write.
10. The minimum Write cycle time for Write Cycle no. 3 ($\overline{WE}$ controlled, $\overline{OE}$ LOW) is the sum of t_{HZWE} and t_{SD}.

Data Retention Characteristics

Over the Operating Range

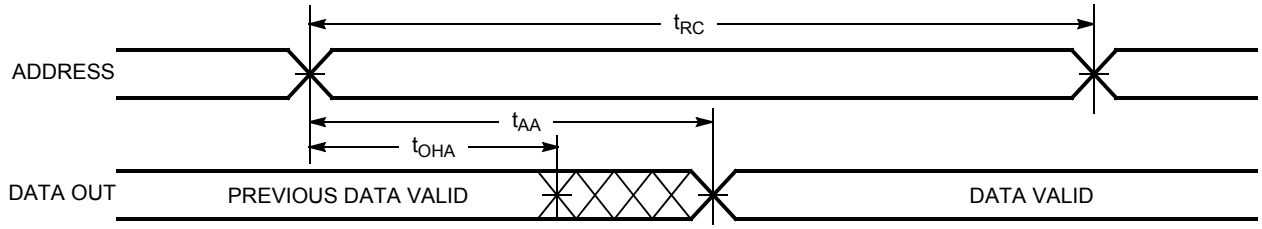
Parameter	Description	Conditions[11]	Min	Max	Unit
V_{DR}	V_{CC} for data retention		2.0	–	V
I_{CCDR}	Data retention current	$V_{CC} = V_{DR} = 2.0$ V, $\overline{CE} \geq V_{CC} - 0.3$ V, $V_{IN} \geq V_{CC} - 0.3$ V or $V_{IN} \leq 0.3$ V	–	10	mA
t_{CDR}[12]	Chip deselect to data retention time		0	–	ns
t_R[13]	Operation recovery time		t_{RC}	–	ns

Data Retention Waveform

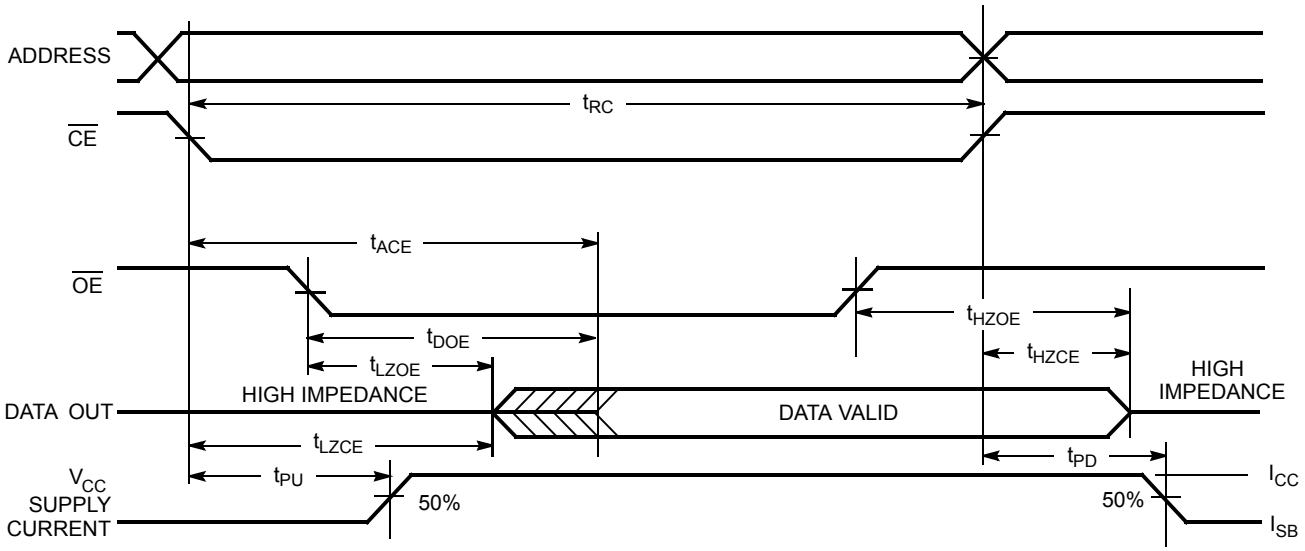


Switching Waveforms

Read Cycle No. 1[14, 15]



Read Cycle No. 2 ($\overline{OE}$ Controlled)[15, 16]

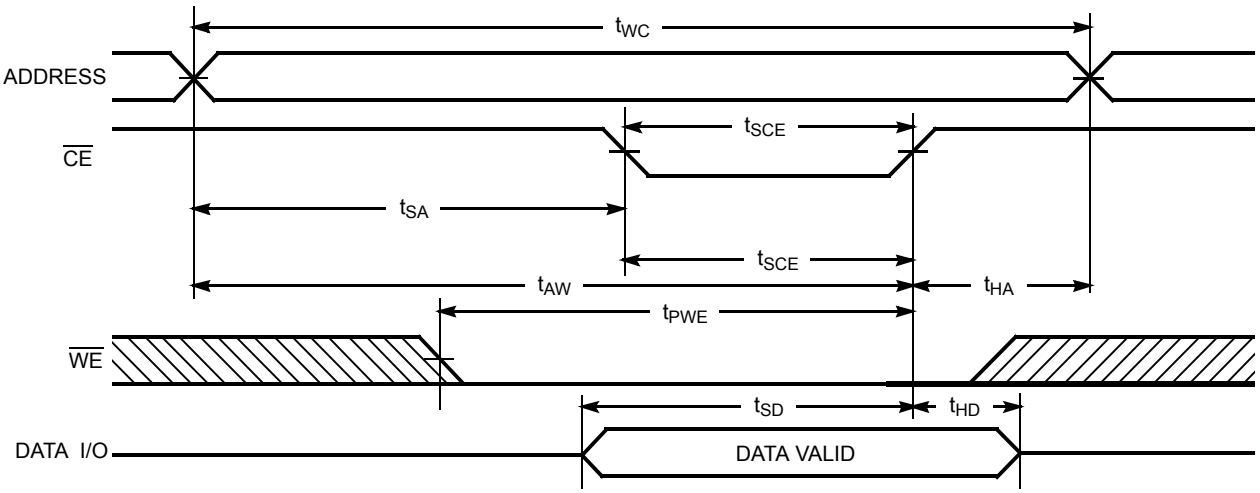


Notes

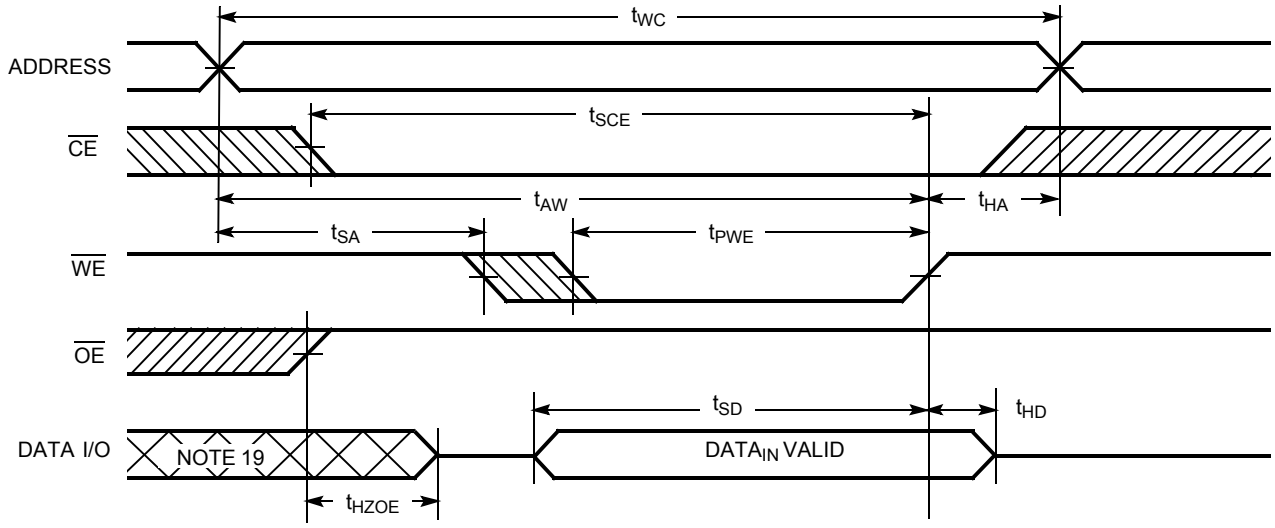
11. No inputs may exceed V_{CC} + 0.3 V.
12. Tested initially and after any design or process changes that may affect these parameters.
13. Full device operation requires linear V_{CC} ramp from V_{DR} to $V_{CC(min.)} \geq 50$ µs or stable at $V_{CC(min.)} \geq 50$ µs.
14. Device is continuously selected. $\overline{OE}$, $\overline{CE} = V_{IL}$.
15. $\overline{WE}$ is HIGH for Read cycle.
16. Address valid prior to or coincident with $\overline{CE}$ transition LOW.

Switching Waveforms *(continued)*

Write Cycle No. 1 ($\overline{CE}$ Controlled)[17, 18]



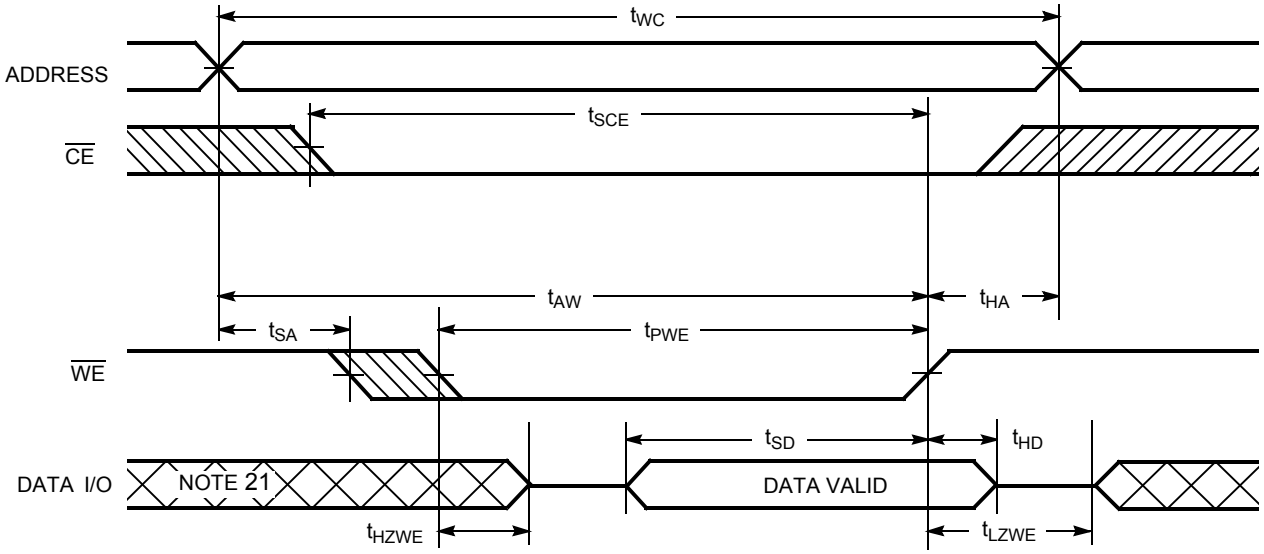
Write Cycle No. 2 ($\overline{WE}$ Controlled, $\overline{OE}$ HIGH During Write)[17, 18]



Notes
17. Data I/O is high impedance if $\overline{OE}$ = V_{IH}.
18. If $\overline{CE}$ goes HIGH simultaneously with $\overline{WE}$ going HIGH, the output remains in a high-impedance state.
19. During this period the I/Os are in the output state and input signals should not be applied.

Switching Waveforms *(continued)*

Write Cycle No. 3 ($\overline{WE}$ Controlled, $\overline{OE}$ LOW)[20]



Truth Table

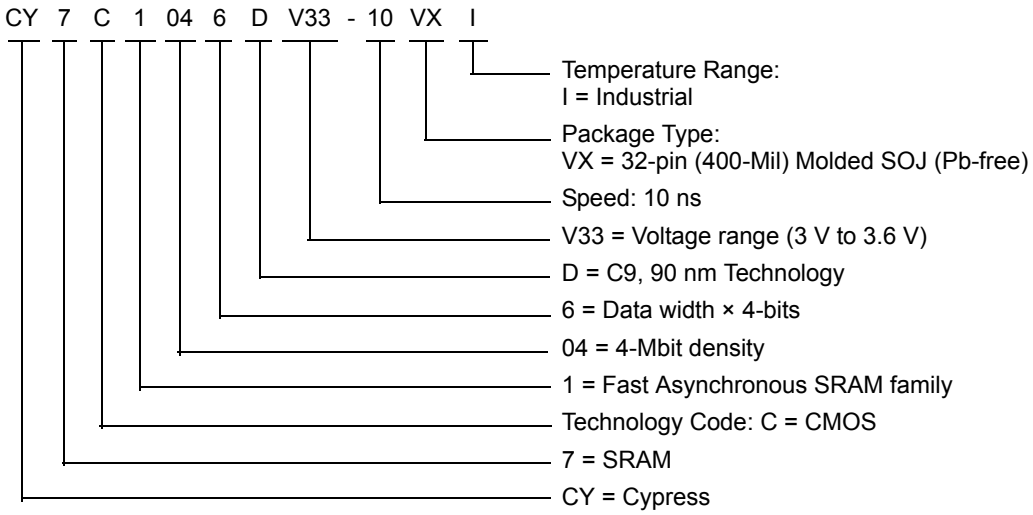
$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	$I/O_0 – I/O_3$	Mode	Power
H	X	X	High Z	Power-down	Standby (I_{SB})
L	L	H	Data out	Read	Active (I_{CC})
L	X	L	Data in	Write	Active (I_{CC})
L	H	H	High Z	Selected, outputs disabled	Active (I_{CC})

Notes
20. If $\overline{CE}$ goes HIGH simultaneously with $\overline{WE}$ going HIGH, the output remains in a high-impedance state.
21. During this period the I/Os are in the output state and input signals should not be applied.

Ordering Information

Speed (ns)	Ordering Code	Package Diagram	Package Type	Operating Range
10	CY7C1046DV33-10VXI	51-85033	32-lead (400-mil) Molded SOJ (Pb-free)	Industrial

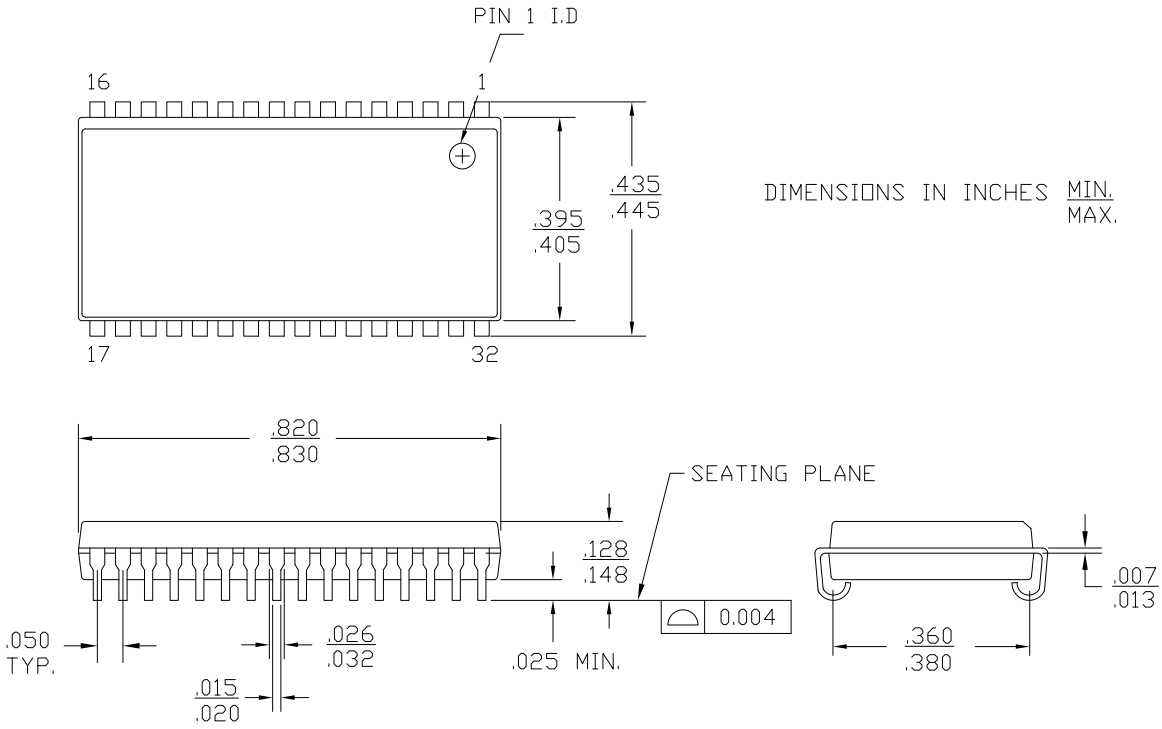
Ordering Code Definitions



Please contact your local Cypress sales representative for availability of these parts.

Package Diagram

32-pin (400-Mil) Molded SOJ (51-85033)



51-85033 *C

Acronyms

Acronym	Description
CMOS	complementary metal oxide semiconductor
CE	chip enable
I/O	input/output
OE	output enable
SOJ	small outline J-lead
SRAM	static random access memory
TTL	transistor-transistor logic
WE	write enable

Document Conventions

Units of Measure

Symbol	Unit of Measure
ns	nano seconds
V	Volts
µA	micro Amperes
µs	micro seconds
mA	milli Amperes
MHz	Mega Hertz
pF	pico Farad
°C	degree Celcius
W	Watts
%	percent

Document History Page

Document Title: CY7C1046DV33 4-Mbit (1 M × 4) Static RAM Document Number: 38-05611				
REV.	**ECN NO.**	**Issue Date**	**Orig. of Change**	**Description of Change**
**	307613	See ECN	RKF	New data sheet
*A	397134	See ECN	RXU	Changed from Advance to Preliminary Changed address of Cypress Semiconductor Corporation on Page# 1 from "3901 North First Street" to "198 Champion Court" Removed -15 Speed bin Corrected DC voltage limits in maximum ratings section from - 0.5 to - 0.3V and V_{CC} + 0.5V to V_{CC} + 0.3V Redefined I_{CC} values for Com'l and Ind'l temperature ranges I_{CC} (Com'l): Changed from 100, 80 and 70 mA to 90, 80 and 75 mA for 8, 10 and 12ns speed bins respectively I_{CC} (Ind'l): Changed from 80 and 70 mA to 90 and 85 mA for 10 and 12ns speed bins respectively Removed footnote on rise time and added footnote on Operation Recovery Time (t_R) Corrected Typo in Truth Table from (I/O_0 - $I/O_{7)}$ to (I/O_0 to $I/O_{3)}$ Changed part names from V33 to V32 in the Ordering Information Table Removed L-Version Added Lead-Free Product Information Shaded Ordering Information Table
*B	459072	See ECN	NXR	Converted from Preliminary to Final Removed -8 and -12 speed bins Removed Commercial Operating Range product information Removed the PIn Definition table Changed the Capacitance value of input pins and I/O pins from 6 pF to 8 pF Updated the Thermal Resistance table Updated footnote #7 on High-Z parameter measurement Added footnote #11 Replaced Package Name column with Package Diagram in the Ordering Information table
*C	3059211	10/14/2010	PRAS	Added Ordering Code Definitions. Updated Package Diagram.
*D	3100106	12/02/2010	PRAS	Added Acronyms and Units of Measure. Minor edits and updated in new template.

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